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	Class	Subclass
		ISSUE CLASSIFICATION

PATENT NUMBER

U.S. UTILITY Patent Application

O.I.P.E.

PATENT DATE

SCANNED

Q.A.

4

APPLICATION NO. 09/716350	CONT/PRIOR D	CLASS 257	SUBCLASS 784	ART UNIT 2815	EXAMINER S. Chen
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TITLE **APPLICANTS**

Bin Zhao

Structure for bonding pad and method for its fabrication

PTO-2040
12/89

ISSUING CLASSIFICATION[illegible]

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED	
	Sheets Drawg.	Figs. Drawg.	Print Fig.	Total Claims
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed. <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent. No. _____ _____ _____	(Assistant Examiner)		(Date)	
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